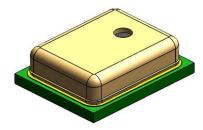
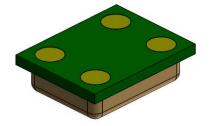


Amplified "Ultra-Mini" SiSonic[™] Microphone Specification With MaxRF Protection





Knowles Acoustics 1151 Maplewood Drive Itasca, IL 60143





1. DESCRIPTION AND APPLICATION

Amplified "Ultra-mini" Surface Mount Silicon 1.1 DESCRIPTION Microphone with Maximum RF Protection

1.2 APPLICATION Consumer electronics

2. PART MARKING

Identification Number Convention

2 3 1

4 5 6 7

S: Identification Marking

"S" - Knowles SiSonic Production

"E" - Knowles Engineering Samples

Digits 1-7: Job Identification Number

3. MATERIALS STATEMENT

- 3.1 Meets the requirements of the European RoHS directive, 2002/95/EC as amended.
- 3.2 Meets the requirements of the industry-standard IEC 61249-2-21:2003 for halogenated substances and Knowles Green Materials Standards Policy section on Halogen-Free.
- 3.3 Ozone depleting substances are not used in the product or the processes used to make the product, including compounds listed in annex A, B, and C of the "Montreal Protocol on Substances that deplete the Ozone Layer."

4. TEMPERATURE RANGE

4.1 Operating Temperature Range: -40 °C to +100 °C

4.2 Storage Temperature Range: -40°C to +100°C



Sheet 2 of 11



5. ABSOLUTE MAXIMUM RATINGS

Parameter	Absolute Maximum Rating	Unit
Supply Voltage, V_{DD} to Ground	-0.5, +5.0	V
OUT to Ground	-0.3, V _{DD} +0.3	V
Input Current to Any Pin	±5	mA

Stresses at these Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only. The device may not function when operated at these or any other conditions beyond those indicated under "Acoustic & Electrical Specifications". Exposure beyond those indicated under "Acoustic & Electrical Specifications" for extended periods may affect device reliability.

6. ACOUSTIC & ELECTRICAL SPECIFICATIONS

TEST CONDITIONS: 23 $\pm 2^{\circ}$ C, 60-70% R.H., V_{DD} (min) $\leq V_{DD} \leq V_{DD}$ (max), no load, Gain = 20 dB, unless otherwise specified

Parameter	Symbol	Condition		Limits		Unit
raidifferei	39111001	Condition	Min.	Nom.	Max.	Offili
Supply Voltage ¹	V_{DD}		1.5		3.6	٧
Current Consumption ¹	I_{DD}			155	205	μΑ
Directivity			Omni-directional		ıl	
Sensitivity ¹	S	94 dB SPL @ 1kHz	-25	-22	-19	dBV/Pa
Signal to Noise Ratio	SNR	94 dB SPL @ 1kHz, A-weighted		59		dB(A)
Output Impedance	Z _{OUT}	@ 1kHz			400	Ω
Total Harmonic	THD	100 dB SPL @ 1kHz, Rload > $2k\Omega$			1	%
Distortion	טווו	115 dB SPL @ 1kHz, Rload > $2k\Omega^2$			10	%
Polarity		Increasing sound pressure	Dec	reasing c	output vo	oltage

^{1 100%} tested



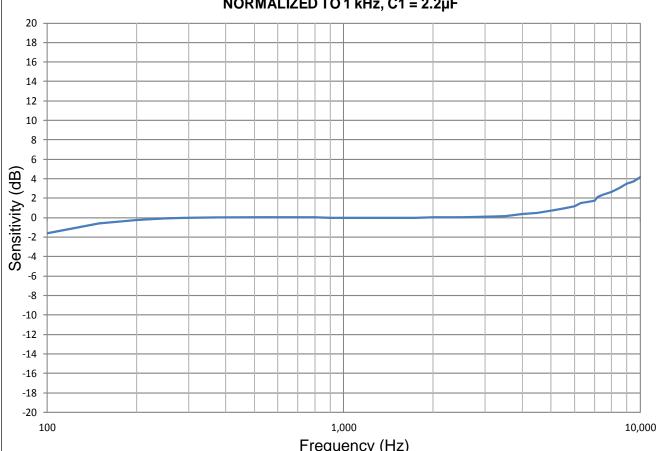
Revision: C Release Level: Active Sheet 3 of 11

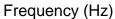
 $^{^2}$ For gain=20 dB, the condition is 95 dB SPL @ 1 kHz



7. FREQUENCY RESPONSE CURVE

TYPICAL FREE FIELD RESPONSE NORMALIZED TO 1 kHz, C1 = 2.2μ F

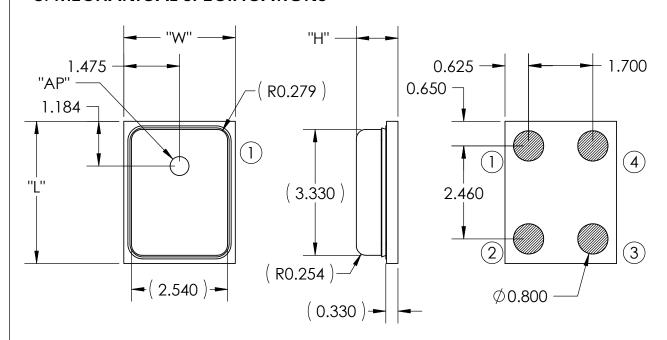








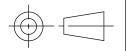
8. MECHANICAL SPECIFICATIONS



ITEM	DIMENSION	TOLERANCE	UNITS
LENGTH (L)	3.760	±0.100	mm
WIDTH (W)	2.950	±0.100	mm
HEIGHT (H)	1.100	±0.100	mm
ACOUSTIC	Ø0 500	+0.100	mm
PORT (AP)	Ø0.500	±0.100	mm

	PIN OUTPUT		
PIN #	FUNCTION		
1	POWER (V _{DD})		
2	GROUND		
3	GAIN		
4	OUTPUT		

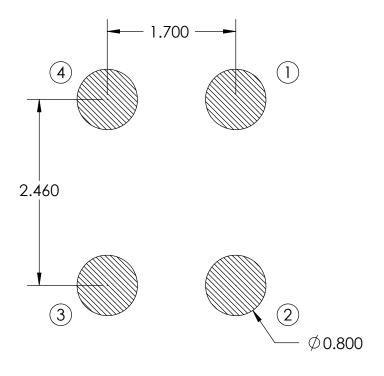
Note:







9. RECOMMENDED CUSTOMER LAND PATTERN

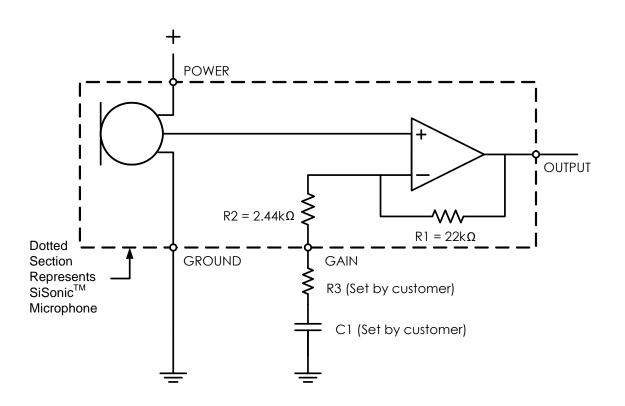


Note: Contact Knowles for Solder Stencil Information





10. RECOMMENDED INTERFACE CIRCUIT

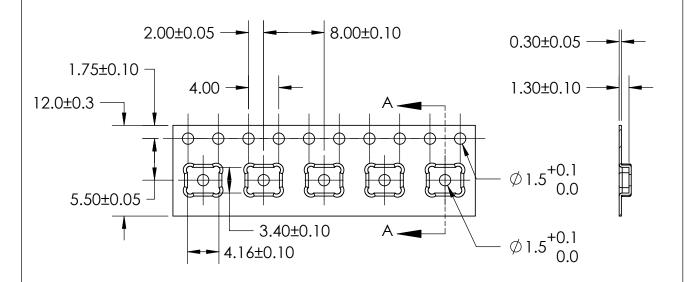


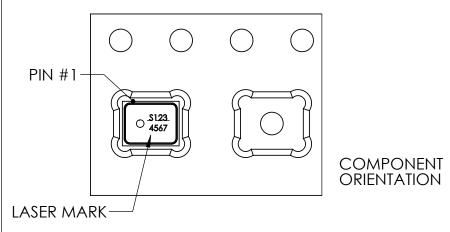
DESIRED GAIN GAIN PIN TERMINATION METHOD	
	DESIRED GAIN
Unity Gain (0dB) Tie Gain Pin directly to Output Pin	Unity Gain (0dB)
20dB Tie Gain Pin through C_1 to Ground (R_3 =0)	20dB
Add R ₃ and C ₁ . Use formulas below to calculate settings $G = 1 + \frac{R_1}{R_2 + R_3}, Gain (dB) = 20 log (G)$ Highpass Corner Frequency $= \frac{1}{2\pi C_1 (R_2 + R_3)}$,





11. PACKAGING DETAIL





MODEL NUMBER	SUFFIX	REEL DIAMETER	QUANTITY PER REEL
SPU0414HR5H-SB	-7	13"	5,700

TAPE & REEL	PER EIA-481
II ABH	LABEL APPLIED TO EXTERNAL PACKAGE &
	DIRECT TO REEL.

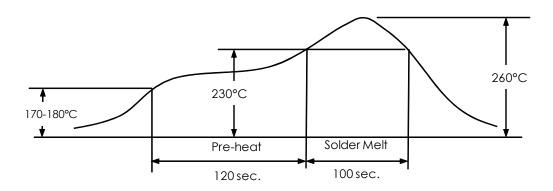
Note:

Dimensions are in milimeters unless otherwise specified.





12. SOLDER REFLOW PROFILE



Stage	Temperature Profile	Time (maximum)
Pre-heat	170 ~ 180°C	120 sec.
Solder Melt	Above 230°C	100 sec.
Peak	260°C maximum	30 sec.

13. ADDITIONAL NOTES

- Shelf life: Twelve (12) months when devices are to be stored in factory supplied, (A) unopened ESD moisture sensitive bag under maximum environmental conditions of 30°C, 70% R.H.
- MSL (moisture sensitivity level) Class 2a.
- <u>Do not pull a vacuum</u> over port hole of the microphone. Pulling a vacum over the port hole can damage the device.
- Do not board wash after the reflow process. Board washing and cleaning agents (D) can damage the device. Do not expose to ultrasonic processing or cleaning. Do not brush board after the reflow process. Brushing the board with/without
- (E) solvents can damage the device.
- Do not insert any object in port hole of device at any time as this can damage (F) the device.
- Number of reflow Recommend no more than 3 cycles. (G)
- <u>Do not apply air pressure into the port hole</u>. Air pressure over 30 psi can damage the device. (H)





14. RELIABILITY SPECIFICATIONS

Note: After test conditions are performed, the sensitivity of the microphone shall not deviate more than 3dB from its initial value.

Test	Description
Thermal Shock	100 cycles of air-air thermal shock from -40°C to +125°C with 15 minute soaks. (IEC 68-2-4)
High Temperature Storage	+105°C environment for 1,000 hours. (IEC 68-2-2 Test Ba)
Low Temperature Storage	-40°C environment for 1,000 hours. (IEC 68-2-2 Test Aa)
High Temperature Bias	+105°C environment while under bias for 1,000 hours. (IEC 68-2-2 Test Ba)
Low Temperature Bias	-40°C environment while under bias for 1,000 hours. (IEC 68-2-2 Test Aa)
Temperature / Humidity Bias	+85°C/85% R.H. environment while under bias for 1,000 hours. (JESD22-A101A-B)
Vibration	4 cycles lasting 12 minutes from 20 TO 2,000 Hz in X, Y and Z direction with peak acceleration of 20g. (MIL 883E, Method 2007.2, A)
Electrostatic Discharge	3 discharges at +/-8kV direct contact to lid when unit is grounded (IEC 61000-4-2) and 3 discharges at +/-2kV direct contact to I/O pins. (MIL 883E, Method 3015.7)
Reflow	5 reflow cycles with peak temperature of +260°C.
Mechanical Shock	3 pulses of 10,000g in the X, Y and Z direction. (IEC 68-2-27, Test Ea)





15. SPECIFICATION REVISIONS

Revision	Detailed Specification Changes	Date
1	Preliminary Specification Release	
Α	Initial Release, C10109400, DMS	4-23-2009
В	Update tables sheets 2, 3, 4, 6, 7. Misc cleanup not changing content.	10-21-2010
С	Add Section 3. Revise part marking (Section 2). Update THD and Idd (Section 6). Update frequency response data (Section 7). Add note H (Section 13). General clean-up and format updates. [C10113596]	04-12-2012
	I	

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